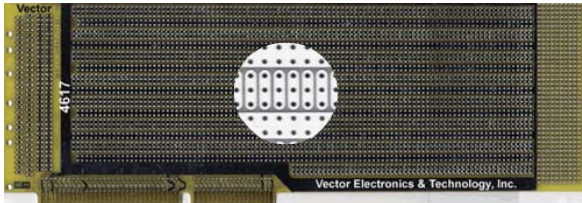


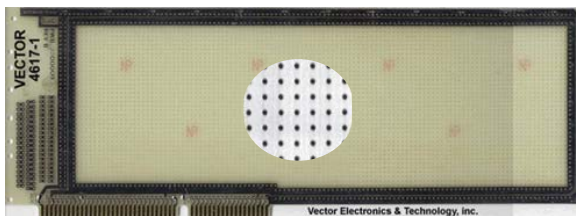
IBM AT/ISA

Plugbord

**4617**

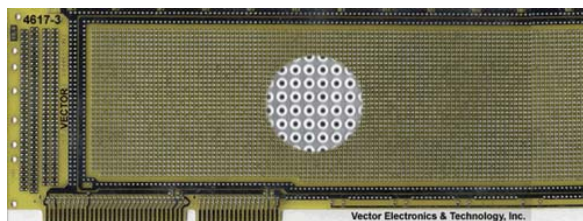
**Circuit Pattern:** 3-hole Solder Pad  
**Contacts:** 98 @ .1" Ctrs  
 Ni/Gold  
**Width/Thick:** 3.25"/.062"  
**Height:** 4.5"  
**16-Pin DIP Capacity:** 44  
**Material:** FR4 Epoxy Glass  
**V/G Terminals:** T44, T46, T49, T68  
**Socket Pins:** R32  
**Extender:** 3690-26, 3690-26-1  
**Hole Diameter:** .042"

- 0.100" grid
- 3-Hole Solder Pads (0.28" x 0.080" for interconnecting multiple component leads
- 10 x 42 hole grid unrestricted component placement area
- I/O mounting area for up to 70-pin D-subminiature and ribbon cable connectors
- Mounting Bracket and hardware kit included (HD36B)
- Layout paper and instructions included
- Row and column legends provided

**4617-1**

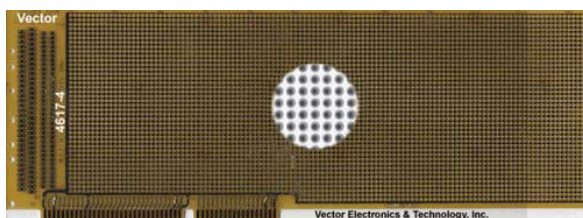
**Circuit Pattern:** Peripheral Buses  
**Contacts:** 98 @ .1" Ctrs  
 Ni/Gold  
**Width/Thick:** 13.25"/.062"  
**Height:** 4.5"  
**16-Pin DIP Capacity:** 108  
**Material:** FR4 Epoxy Glass  
**V/G Terminals:** T44, T46, T49, T68  
**Socket Pins:** R32  
**Extender:** 3690-26, 3690-26-1  
**Hole Diameter:** .042"

- 0.100" grid
- Bus surfaces solder-coated for convenience
- I/O mounting area for 37-pin D-subminiature and ribbon cable connectors
- Mounting Bracket and hardware kit included (HD36B)
- Layout paper and instructions included
- Row and column legends provided

**4617-3**

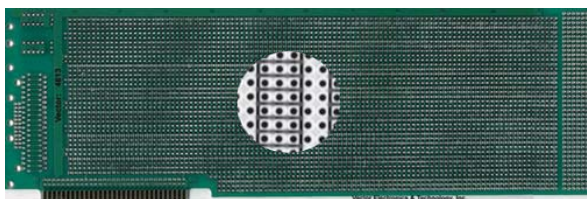
**Circuit Pattern:** Pad-Per-Hole  
**Contacts:** 98 @ .1" Ctrs  
 Ni/Gold  
**Width/Thick:** 13.25"/.062"  
**Height:** 4.5"  
**16-Pin DIP Capacity:** 96  
**Material:** FR4 Epoxy Glass  
**V/G Terminals:** T44, T46, T49, T68  
**Socket Pins:** R32  
**Extender:** 3690-26, 3690-26-1  
**Hole Diameter:** .042"

- 0.100" grid
- Voltage and ground buses around board perimeter
- Pad and bus surfaces solder-coated for convenience
- I/O mounting area for up to 70-pin D-subminiature and ribbon cable connectors
- Mounting Bracket and hardware kit included (HD36B)
- Layout paper and instructions included
- Hole position legend provided, both sides
- Plate thru holes

**4617-4**

**Circuit Pattern:** Voltage Ground Plane  
**Contacts:** 98 @ .1" Ctrs  
 Ni/Gold  
**Width/Thick:** 13.25"/.062"  
**Height:** 4.5"  
**16-Pin DIP Capacity:** 140  
**Material:** FR4 Epoxy Glass  
**V/G Terminals:** R50, R51, R52, R53  
**Socket Pins:** R32  
**Extender:** 3690-26, 3690-26-1  
**Hole Diameter:** .055"

- 0.100" grid
- Plane surfaces solder-coated for user convenience
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)
- Layout paper and instructions included
- Mounting Bracket and hardware kit included (HD36B)
- I/O mounting area for up to 70-pin D-subminiature and ribbon cable connectors

IBM PC, XT**4613**

**Circuit Pattern:** 3-Hole Solder Pad  
**Contacts:** 31/62 @ .1" Ctrs  
 Ni/Gold  
**Width/Thick:** 13.25"/.062"  
**Height:** 4.2"  
**16-Pin DIP Capacity:** 93  
**Material:** FR4 Epoxy Glass  
**V/G Terminals:** T44, T46, T49, T68  
**Socket Pins:** R32  
**Extender:** 3690-26  
**Hole Diameter:** .042"

**IBM PC, XT**

- 0.100" grid
- 3-Hole Solder Pads (0.28" x 0.080" for interconnecting multiple component leads
- I/O mounting area for 37-pin D-subminiature and ribbon cable connectors
- Mounting Bracket and hardware kit included (HD36B)
- Layout paper and instructions included

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